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Biomolecular recognition on nanowire surfaces modified by the self-assembled monolayer

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This PDF file includes: Figs. S1 to S4



Figure S1. (a) Schematic illustrations of fabrication procedures for MPC-SH SAM modified nanowires in a microchannel: (i) washing the Si substrate; (ii) microchannel patterning using OAP and OFPR8600; (iii) microchannel etching using DRIE; (iv) ZnO layer sputtering; (v) ZnO nanowires being fabricated by hydrothermal growth; (vi) Au sputtering; (vii) removing OAP and OFPR8600; (viii) modifying the MPC-SH SAM; and (ix) covering with a PDMS sheet. (b) A photo of MPC-SH SAM modified nanowires in a microchannel (scale bar, 1 cm). (c) Reaction scheme of MPC-SH SAM modification.



Figure S2. (a) FESEM images of nanowires fabricated from different thicknesses of ZnO layers (10, 20, 50, and 100 nm; upper images, top view; lower images, cross-sectional view; scale bars, 200 nm). (b) (i) Diameter (N=200), (ii) length (N=50) and (iii) orientation angle (N=50) of nanowires (black, 10 nm; red, 20 nm; blue, 50 nm; green, 100 nm). These were measured from FESEM images.



Figure S3. (a) FESEM images of Au-coated nanowires fabricated with different sputtering times (0, 15, 30, and 60 s; upper images, top view; lower images, cross-sectional view; scale bars, 200 nm). These nanowires were fabricated from the 100 nm ZnO layer. (b) Diameter (N>100) of nanowire tips (black, green, red, and blue correspond to 0, 15, 30, and 60 s sputtering times, respectively). These were measured from FESEM images.



Figure S4. (a) Schematic illustrations of fabrication procedures for MPC-SH SAM modified flat surfaces prepared for the atomic force microscopy (AFM) measurement; (i) washing the Si substrate; (ii) sputtering the ZnO layer (~ 100 nm); (iii) sputtering the Au layer (~89 nm); (iv) modifying the MPC-SH SAM. (b) AFM image of Au/ZnO/Si substrate (before MPC-SH modification) and (c) AFM image of MPC-SH/Au/ZnO/Si substrate (after MPC-SH modification).